



深圳市拓展光电有限公司

TuoZhan Optoelectronics Company Limited

产品规格书

Product Specification

产品料号/ Part No.	P2-0805PT1TS2-08T-002		
产品名称/ Product Name	0805红外发射管		
客户名称/ Customer Name			
客户料号/ Customer No			
生效日期/ Effective Date			
制作 Prepared	审核 Checked	核准 Approved	业务 Sales
客户确认（盖章） Customer confirmation（Stamp）			

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注：如中英译文有冲突请以中文为准。

Note: In case of any conflict between Chinese and English translations, the Chinese version shall prevail.



拓展光电

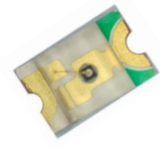
TUOZHANGUANGDIAN

版本	修订日期	文件修订内容	备注
A0	2022/8/11	首次发行	田在松

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版本号	A0	受控日期	2022年08月11日	



P2-0805PT1TS2-08T-002 Datasheet



0805 infrared emitting tube, which can directly convert electric energy into near-infrared light and radiate it at the same time, is widely used in Bluetooth, computer wireless data transmission, household appliances, medical appliances, cameras and so on.

0805 红外发射管，它是可以将电能直接转换成近红外光同时辐射出去的发光器件，被广泛的应用于蓝牙，电脑无线数据传输、家用电器、医疗器具、摄像机等。

This part has a footprint that is compatible to most of LEDs with similar size.

此器件可与大部份外形尺寸相似的LED兼容使用

FEATURES/特点

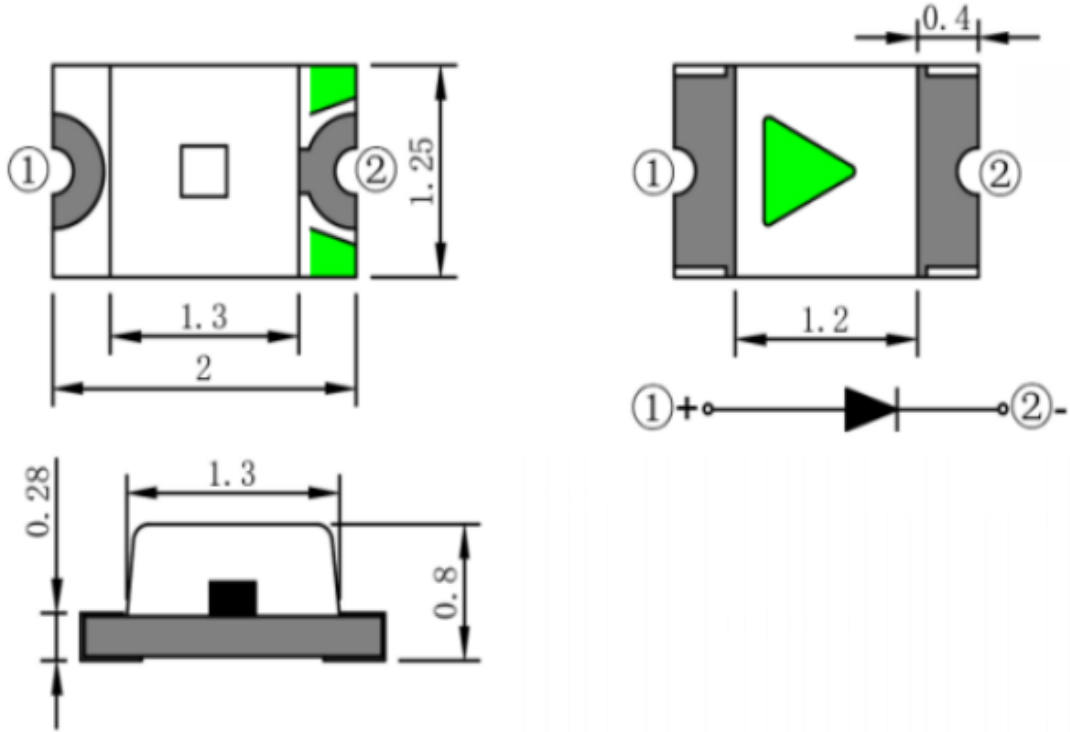
- sturdy and durable/坚固耐用
- Long operation life/寿命长
- Wide viewing angle at 120°
120° 发光角度
- Epoxy resin package/环氧树脂封装
- Environmental friendly, RoHS compliance
材质环保，符合RoHS要求

APPLICATIONS/应用

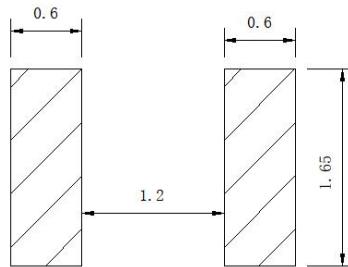
- Digital products/数码产品
- household appliances/家用电器



外观尺寸及建议焊盘尺寸: **Size of Appearance & Suggested Soldering PAD**



Recommended Solder Pad Design 推荐焊盘设计



For reflow soldering

Notes/ 注:

1. All dimensions in millimeters.所有尺寸单位为mm
2. Tolerance is ± 0.1 mm unless otherwise noted. 如未特别注明，默认公差为 ± 0.1 mm

**ABSOLUTE MAXIMUM RATINGS**最大限定参数 (Ta=25°C)

Parameter 参数	Symbol 符号	Value 额定值	Unit 单位
Power Dissipation 消耗功率	Pd	30	mW
Max Pulse Current 最大脉冲电流	IFP	70	mA
DC Forward Current 正向直流工作电流	IF	30	mA
Reverse breakdown Voltage 反向电压	VR	5	V
Electrostatic Discharge Threshold (HBM) 抗静电能力	ESD	2000	V
Operating Temperature 工作环境温度	Topr	-40 to 85°C	°C
Storage Temperature 储存环境温度	Tstg	-40 to 85°C	°C
Soldering Temperature 焊接温度	Tsol	Reflow soldering (回流焊) : 260°C/10S Hands soldering (手工焊) : 320°C/3S	°C

CHARACTERISTICS 光电参数(Ta=25°C)

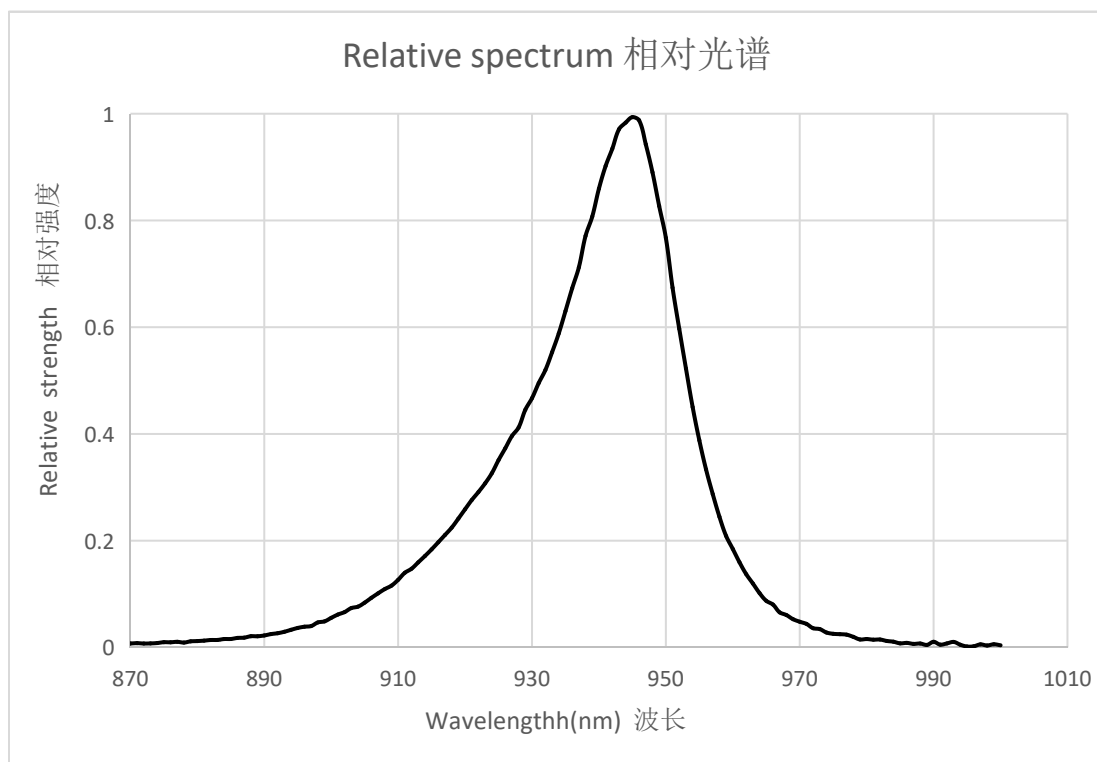
Parameter 项目名称	Symbol 符号	Condition 条件	Min 最小值	Typ 中间值	Max 最大值	Unit 单位
Radiation Intensity 辐射强度	Ie	IF=20mA	---	0.53398	---	mW/sr
Forward Voltage 正向电压	VF	IF=20mA	---	1.25	---	V
Peak Wavelength 峰值波长	λ_P	IF=20mA	---	940	---	nm
Reverse Current 反向漏电流	IR	VR=5V	---	---	3	uA
Half Power View 半功率视角	2 θ 1/2	IF=20mA	---	120	---	deg

Notes/注:

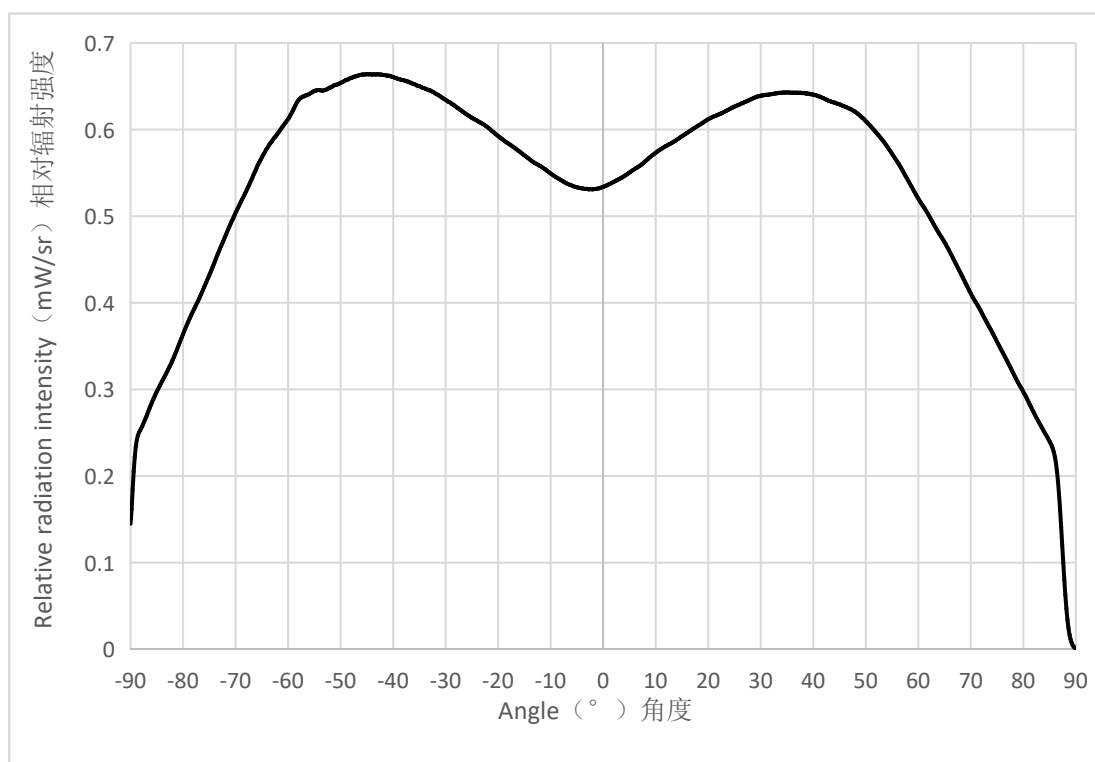
1. peak wavelength is measured with an accuracy of $\pm 2\text{nm}$. 峰值波长的测量精度为 $\pm 2\text{nm}$.
2. All measurements were made under the standardized environment of Tuozhan
所有的测量都是在拓展的标准环境下进行的



RELATIVE SPECTRAL POWER DISTRIBUTION 相对光谱功率分布 ($T_j=25^\circ\text{C}$)

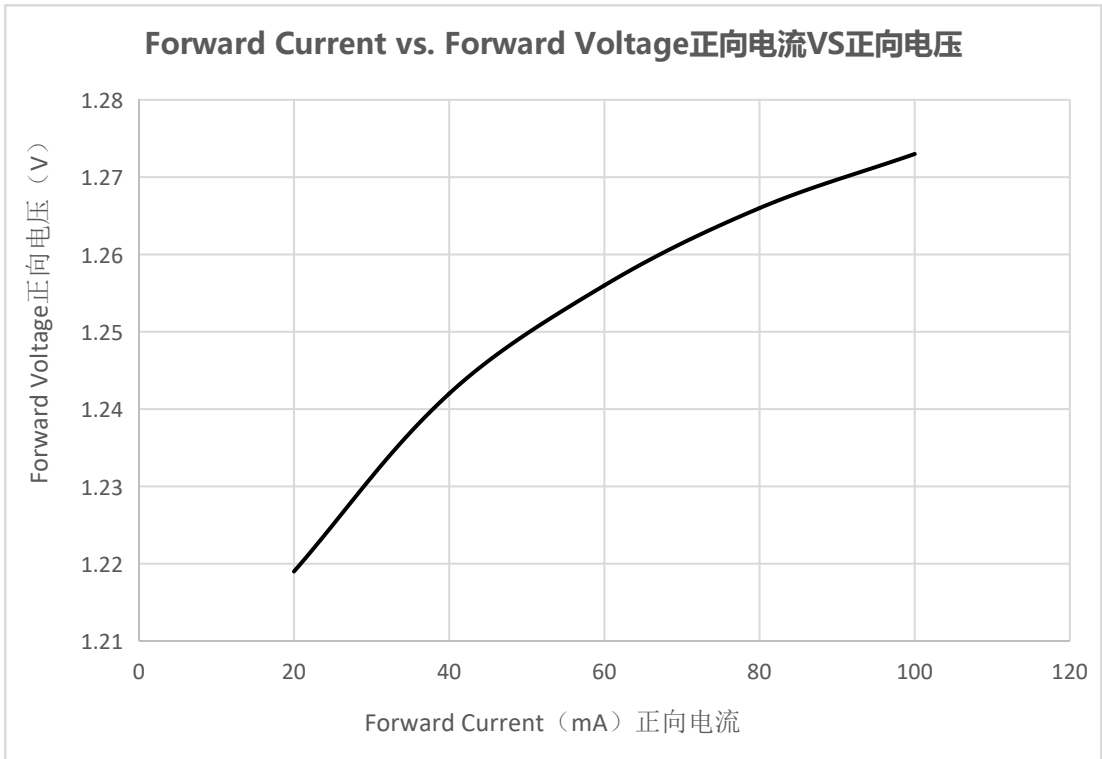


**Relation curve between relative radiation intensity and space angle
相对辐射强度和空间角关系曲线**

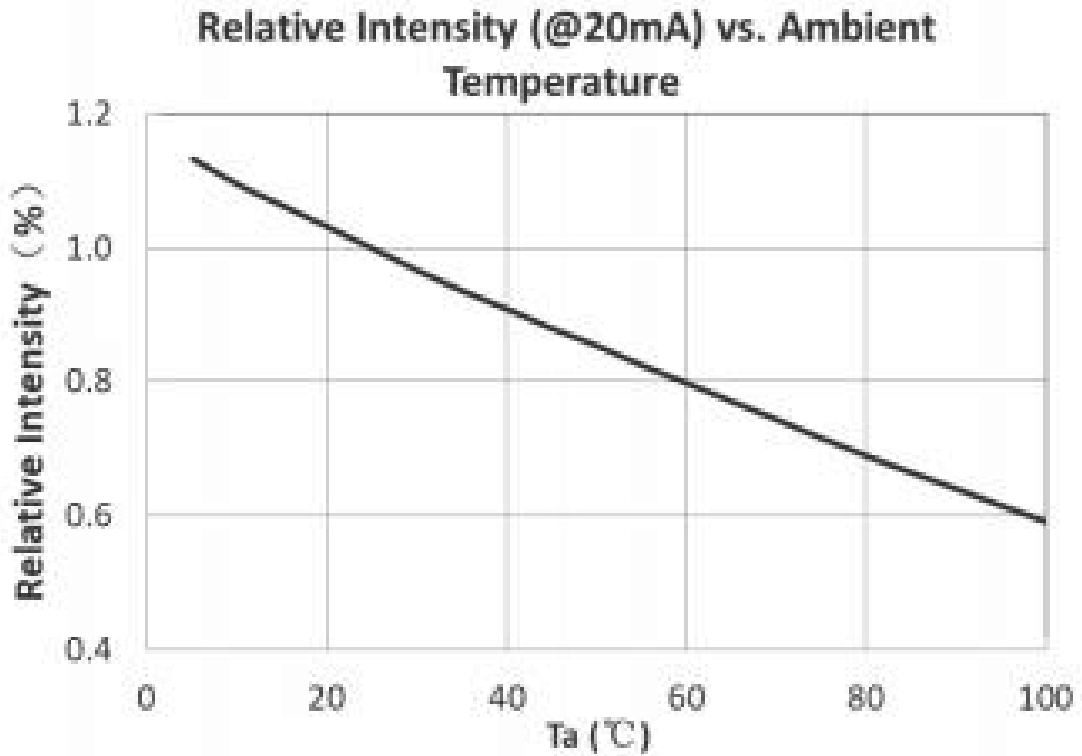




ELECTRICAL CHARACTERISTICS 电特性(Tj=25°C)



Chip temperature and forward voltage curve 芯片温度与正向电压曲线





REFLOW SOLDERING CHARACTERISTICS 回流焊特性

For Reflow Process 回流焊制程:

Preheating 预热 : 140°C~160°C±5°C, within 2 minutes. 2分钟

Operation heating 作业加热 : 260°C(Max.) within 10 seconds.(Max)

260°C(最高) within 10 seconds.(最长)

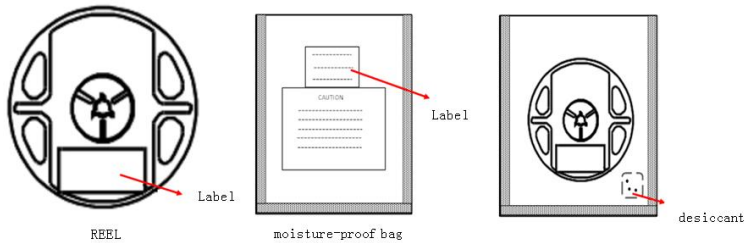
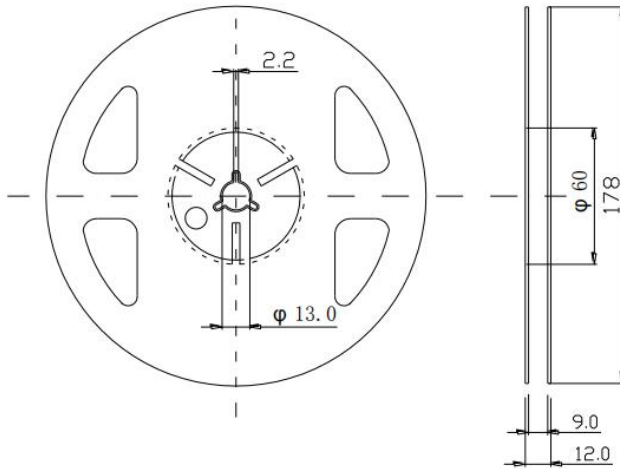
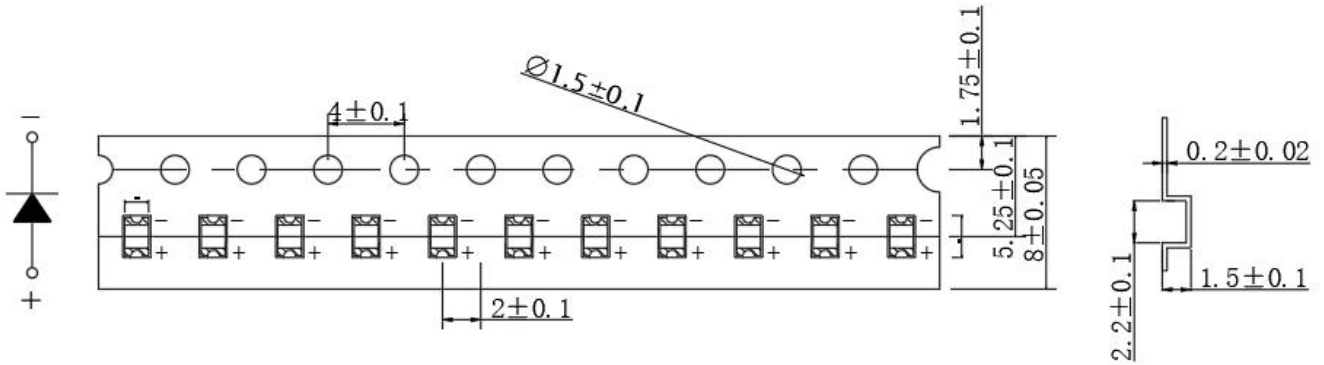
Gradual Cooling (Avoid quenching). 逐渐冷却(避免淬火)

Lead solder 有铅焊接		Lead-free solder 无铅焊接	
Pre-heat 预热	120-150°C	Pre-heat 预热	150-200°C
Pre-heat time 预热时间	120 sec.Max.	Pre-heat time 预热时间	120 sec.Max.
Peak Temperature 峰值温度	240°C Max.	Peak Temperature 峰值温度	260°C Max.
Soldering time condition 回流焊时间	10 sec.Max.	Soldering time condition 回流焊时间	10 sec.Max.

<p style="text-align: center;">Lead Solder</p>	<p style="text-align: center;">Lead-free Solder</p>
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TAPE AND REEL 编带NO.1



Notes注:

- (1) Quantity : 4,000pcs/Reel
数量: 4000pcs/卷
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be $\pm 0.2\text{mm}$
累积公差: 累积公差/10间距 ± 0.2 毫米
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 20-40N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape
盖带粘附强度: 盖带反向拉, 与载带角度为 10° , 拉力为 20-40N
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.
包装: 品名, 生产数据代码和数量须在防潮包装上注明



Reliability Test Items 可靠性测试项目

Test Items 测试项目	Test Duration 测试时长	Number of Damaged 不良数
Steady State Operating Life of High Temperature (HTOL) $T_s=85^{\circ}\text{C}$, IF=Max 高温点亮稳态老化 $T_s=85^{\circ}\text{C}$, IF=最大值	1000hrs	0/20
Steady State Operating Life of Low Temperature (LTOL) $T_a=-40^{\circ}\text{C}$, IF=Max 低温点亮稳态老化 $T_s=85^{\circ}\text{C}$, IF=最大值	1000hrs	0/20
Pulse Wet Operating Life of High Temperature (PWHTOL) 高温高湿通断电老化 $60^{\circ}\text{C}/90\%\text{RH}$, IF30mins ON/30min OFF	500hrs	0/20
High Temperature Storage (HTS) 高温存储 100°C	1000hrs	0/20
Low Temperature Storage (LTS) 低温存储 -40°C	1000hrs	0/20
Thermal Shock (TS) $-45^{\circ}\text{C}\sim 125^{\circ}\text{C}$ 30min dwell 20sec transfer 冷热冲击 -45°C 30min $\sim 125^{\circ}\text{C}$ 30min, 转换时间20秒	300cycles	0/20
Solder Resistance (SR) 265°C , 3X MSL 阻焊测试 (3遍潮气敏感度试验后)	5sec	0/20
Solder Ability (SA) 245°C 5sec, 95% coverage 可焊性 95%覆盖	5sec	0/11
Mechanical Shock (MS) 1500G 0.5msec pulse shock 机械冲击(MS) 1500G 0.5毫秒脉冲冲击	Each6 axis	0/6
Random Vibration (RV) 随机振动 6G RMS, 10-2000Hz, 10min	Per axis	0/6
Variable Vibration Frequency (VVF) 10-2000-10Hz, log or linear sweep rate, 20G for 1 min, 1.5mm each apply 3x per axis over 变频振动(VVF) 10-2000-10Hz, 对数或线性扫频, 20G, 1分钟, 1.5mm, 每轴3遍以上	6hrs	0/6
Salt Spread (SS) 35°C , 30g/m ² /day 盐雾试验 35°C ,30克/平方米/天	48hrs	0/11

Item 项目	Symbol 符号	Test Condition 测试条件	Criteria for Judgment 判定标准	
			Min. 最小	Max. 最大
Forward Voltage 正向电压	V_f	IF=Typical Current 典型电流		U.S.L x1.1
Light intensity 光强	mcd	IF=Typical Current	L.S.L x0.7	
peak wavelength 峰值波长	nm	IF=Typical Current		U.S.L x1.1



PRECAUTION FOR USE 使用注意事项

(1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA should be used.

本器件不得用于水、油、有机溶剂等任何流体中。如需清洁，请使用异丙醇进行清洗。

(2) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.

当LED发光工作时，应根据环境最高温度来确定工作电流。

(3) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from TuoZhan, a sealed container with a nitrogen atmosphere should be used for storage.

LED储存环境须保持清洁。如果LED从拓展发货后需储存3个月或更长时间，则应使用氮气柜进行储存。

(4) The LEDs must be used within seven days after opening the moisture proof packing.

Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.

LED须在打开防潮包装后七天内使用。用防潮包装重新包装未使用的产品，折叠以封住开口，然后存放在干燥的地方。

(5) The appearance and specifications of the product may be modified for improvement without notice.

产品外观及规格如有改进，恕不另行通知。

(6) This LED is sensitive to the static electricity and surge. It is recommended to use a wrist Band or anti-electrostatic glove when handling the LEDs.

LED对静电和浪涌很敏感。在处理LED时，建议使用防静电腕带或防静电手套。

(7) On manual soldering, a solder tip must be needed as grounded for usage. If over voltage which exceeds the absolute maximum rating is applied to LEDs, it will cause damage LEDs and result in destruction. Damaged LEDs will show some unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LEDs get unlighted at low current.

手工焊接时，焊接头必须接地。如果对led施加超过绝对最大额定值的过电压，会对led造成损坏。损坏的led会出现一些不寻常的特性，如漏电流明显增加，接通电压降低，低电流时led不亮。